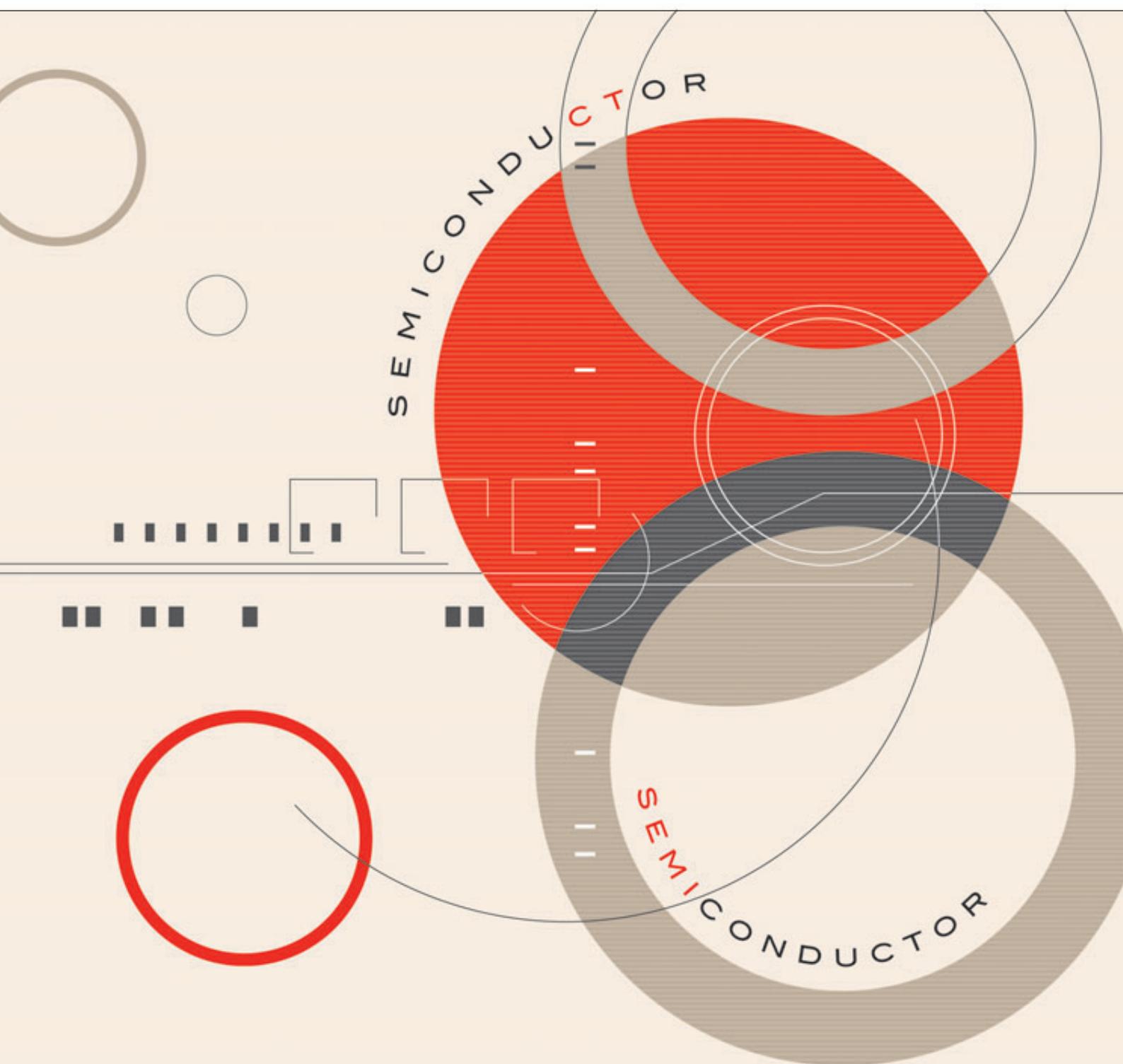


PRODUCT GUIDE**Discrete IGBTs**

1 Features and Structure

IGBT: Insulated Gate Bipolar Transistor

IGBTs combine the MOSFET advantage of high input impedance with the bipolar transistor advantage of high-voltage drive.

The conductivity modulation characteristics of a bipolar transistor make it ideal for load control applications that require high breakdown voltage and high current.

Toshiba offers a family of fast switching IGBTs, which are low in carrier injection and recombination in carrier.

► Features of the Toshiba Discrete IGBTs

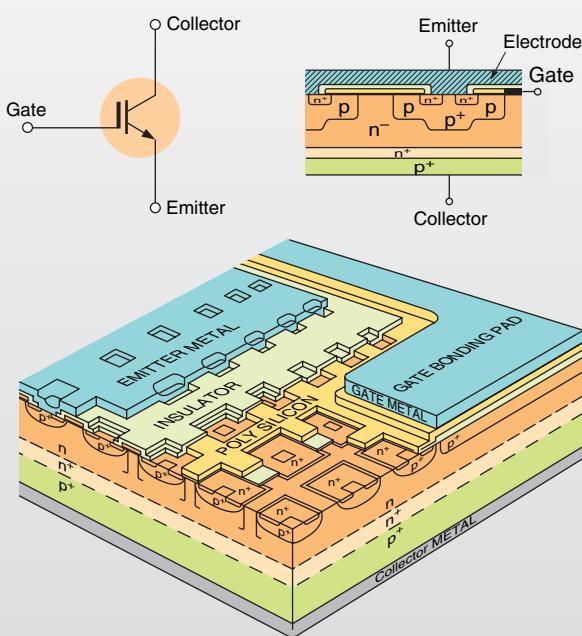
The Toshiba discrete IGBTs are available in high-voltage and high-current ratings. They are used in inverter and power conversion circuits for such diverse applications as motor drivers, uninterruptible power supply (UPS) systems, IH cookers, plasma display panels (PDPs), strobe flashes and so on.

- (1) IGBTs also featuring fast switching
- (2) Low collector-emitter saturation voltage even in the large current area
- (3) IGBTs featuring a built-in diode with optimal characteristics tailored to specific applications
- (4) High input impedance allows voltage drives
- (5) Available in a variety of packages

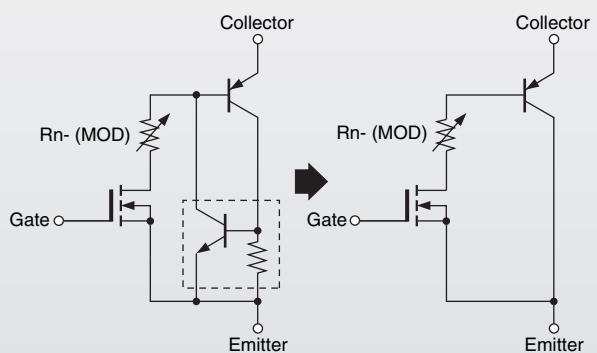
► Construction

The basic structure of the planar IGBT consists of four layers (pnpn), as shown in the following figure. Low saturation voltage is achieved by using a pnp transistor to allow conductivity modulation during conduction.

► Planar Structure



► Equivalent Circuit



2 IGBT Technical Overview

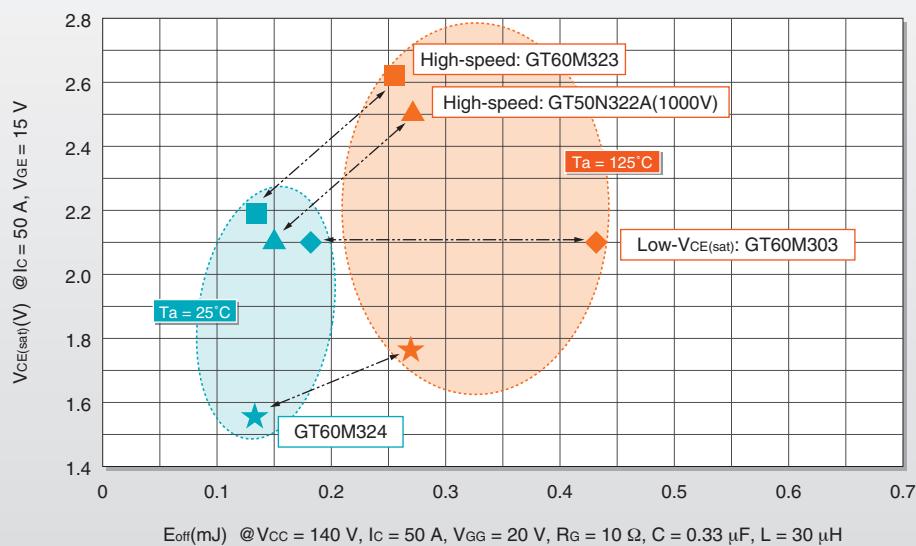
Prior to the development of IGBTs, power MOSFETs were used for power amplifier applications which require high input impedance and fast switching. However, at high voltages, the on-state resistance rapidly increases as the breakdown voltage increases. It is thus difficult to improve the conduction loss of power MOSFETs.

On the other hand, the IGBT structure consists of a pnp bipolar transistor and a collector contact made on the p⁺ layer. The IGBT has a low on-state voltage drop due to conductivity modulation.

The following figure shows the V_{CE(sat)} curve of a soft-switching 900-V IGBT. Toshiba has offered IGBTs featuring fast switching by using carrier lifetime control techniques. Now, Toshiba offers even faster IGBTs with optimized carrier injection into the collector p⁺ layer.

In the future, Toshiba will launch IGBTs with varied characteristics optimized for high-current-conduction and high-frequency-switching applications. The improvements in IGBTs will be spurred by optimized wafers, smaller pattern geometries and improved carrier lifetime control techniques.

► 900-V IGBT for Soft-Switching



► Discrete IGBT Development Trends

1200 V	(1) High ruggedness (3rd gen): Low V _{CE(sat)} and high ruggedness due to optimized carrier injection and thinner wafers		
	(2) Soft switching (5th gen): Low V _{CE(sat)} due to trench gate structure		
	(3) Soft switching (6.5th gen): RC structure		
900 to 1500 V	(1) Soft switching (4th gen): Low V _{CE(sat)} due to trench gate structure		
	(2) Soft switching (5th gen): Low V _{CE(sat)} due to optimized carrier injection and trench gate structure		
	(3) Soft switching (6th gen): Thinner wafers and finer process geometries		
600 V	(1) High ruggedness (3rd gen): Low V _{CE(sat)} and high ruggedness due to optimized carrier injection and thinner wafers		
	(2) Fast switching (4th gen): High speedy tf due to optimized carrier injection		
	(4) Low V _{CE(sat)} (6th gen): Thinner wafers and finer process geometries		
400 V	(3) Soft switching (4th gen): Low V _{CE(sat)} due to trench gate structure		
	(5) Soft switching (5th gen): Thinner wafers		
	(6) Soft switching (6th gen): Thinner wafers and finer process geometries		
300 to 400 V	(1) Strobe flashes (5th gen): Low V _{CE(sat)} due to trench gate structure		
	(2) Strobe flashes (6th gen): High current due to trench gate structure and optimized wafers		
	(3) Strobe flashes (7th gen): High current due to optimized wafers and finer process geometries		



3 Discrete IGBT Product Lineup

Applications and Features	Breakdown Voltage V_{CES} (V) @ $T_a = 25^\circ C$	IGBT Current Rating I_C (A) @ $T_a = 25^\circ C$		TSOn-8	SOP-8	TO-220SIS	TO-220SM(MXN)	TO-3P(N)	TO-3P(N)IS	TO-3P(LH)
		DC	Pulse							
General-purpose motors General-purpose inverters Hard switching fc: up to 20 kHz High ruggedness Series	600	10	20					GT10J301		
		20	40					GT20J301		
		30	60					GT30J301		
		50	100					GT30J101		
	1200	10	20					GT10Q301		
		15	30					GT15Q301		
		25	50					GT15Q102		
									GT25Q301	GT25Q102
General-purpose inverters Fast switching Hard switching fc: up to 50 kHz FS series	600	30	60					GT30J324	GT30J126	
		50	100					GT30J121		
	600	30	100					GT30J322		
		37	100					GT35J321		
		40	100					GT40J321	GT40J325	
		50	100					GT40J322		
			120					GT40J323		
		60	120					GT50J327		
								GT50J341		
								GT50J328		
Resonant switching Soft switching Soft-Switching Series	900	15	30					GT60J321		
		35	100					GT60J323		
		50	100					GT60J32H		
			120							
		60	120							
		15	30					GT15M321		
		35	100					GT35MR21		
	1000	50	100							
			120							
		60	120							
PFC	600	50	120					GT50N322A		
		60	120					GT50N324		
Strobe flashes	400	50	100					GT50NR21		
		1050	50	100				GT40QR21		
		1200	40	80				GT40T321		
		1500	40	80						
		30	100					GT30J122A	GT30J122	
		40	100						GT40J121	
Plasma display panels		130	GT5G133							
		150	GT8G151	GT8G132						
		200		GT10G131						
		300	200				GT30F124			
		330	200				GT45F127			
		360	200				GT30F125			
							GT45F128			
		430	200					GT30F131		
		600	200				GT30G124			
							GT30G125			
							GT45G127			
							GT45G128			
							GT30J124			

: New product

4 Part Numbering Scheme

Example **GT 60 M 3 03 A**

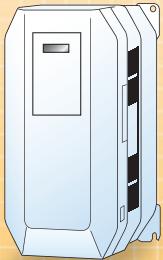
Table 1

Letter	Voltage (V)	Letter	Voltage (V)	Letter	Voltage (V)
C	150	J	600	Q	1200
D	200	K	700	R	1300
E	250	L	800	S	1400
F	300	M	900	T	1500
G	400	N	1000	U	1600
H	500	P	1100	V	1700

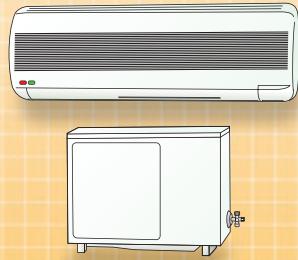
5-1 General-Purpose Inverter

The fast-switching (FS) series, a new addition to our third-generation IGBTs, features high ruggedness which helps to improve the energy efficiency of electronic equipment.

General-Purpose
Inverters



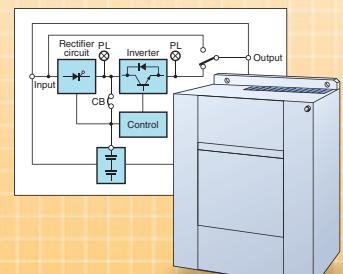
Inverter Air
Conditioners



Inverter Washing
Machines



UPS



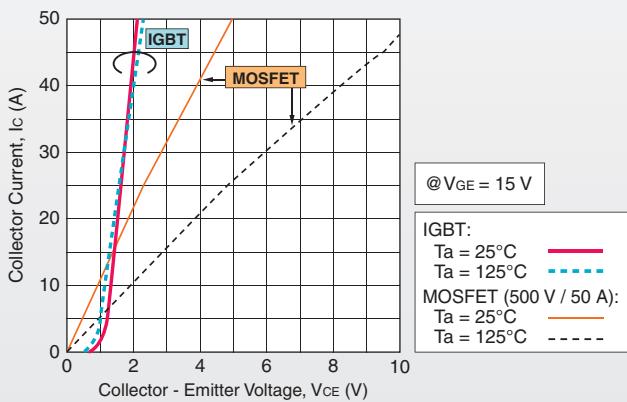
Discrete IGBT Trend

► For general-purpose inverters

Our 3rd generation low-loss and low-noise IGBTs are ideal for inverter applications to reduce switching loss and thus improve energy efficiency. The following graphs compare the thermal and turn-on characteristics of our 3rd generation IGBTs and 500-V MOSFETs

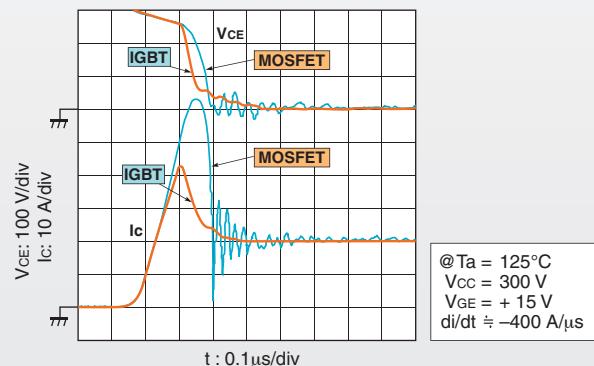
► IC - V_{CE} Temperature Characteristics

Low saturation voltage with minimal temperature dependence



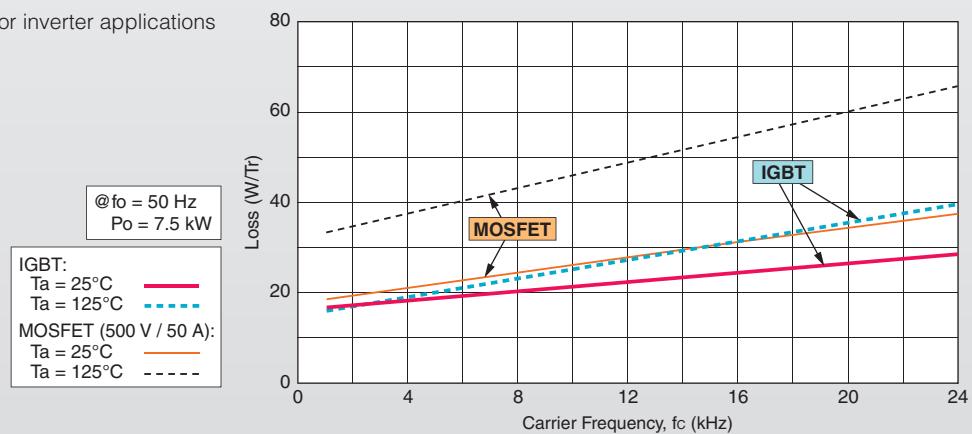
► Turn-On Waveform

Fast reverse-recovery characteristics due to built-in diode with optimal characteristics



► Power Loss vs. Carrier Frequency Characteristics

Simulation data for inverter applications

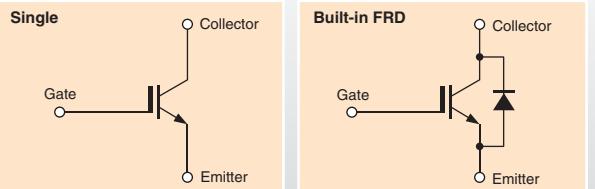


5-1 General-Purpose Inverter

Product Lineup

► For general-purpose inverters

► Circuit Configurations



► 600-V and 1200-V IGBTs

Main Applications	Features	Part Number	Absolute Maximum Ratings				Package	Circuit Configuration (*1)	VCE(sat) Typ.			tr Typ.	Load (*2)	Remarks			
			V _{CES} (V)	I _c		P _c			(V)	@I _c (A)	@V _{GE} (V)						
				DC (A)	Pulsed (A)	T _c = 25°C (W)											
Motor driving (UPS/PFC)	High V _{CES} (1200V)	GT10Q101	1200	10	20	140	TO-3P(N)	◆	2.1	10	15	0.16	L				
		GT10Q301	1200	10	20	140	TO-3P(N)	Built-in FRD	2.1	10	15	0.16	L				
		GT15Q102	1200	15	30	170	TO-3P(N)	◆	2.1	15	15	0.16	L				
		GT15Q301	1200	15	30	170	TO-3P(N)	Built-in FRD	2.1	15	15	0.16	L				
		GT25Q102	1200	25	50	200	TO-3P(LH)	◆	2.1	25	15	0.16	L				
		GT25Q301	1200	25	50	200	TO-3P(LH)	Built-in FRD	2.1	25	15	0.16	L				
	High V _{CES} (600V)	GT10J301	600	10	20	90	TO-3P(N)	Built-in FRD	2.1	10	15	0.15	L				
		GT20J101	600	20	40	130	TO-3P(N)	◆	2.1	20	15	0.15	L				
		GT20J301	600	20	40	130	TO-3P(N)	Built-in FRD	2.1	20	15	0.15	L				
		GT30J101	600	30	60	155	TO-3P(N)	◆	2.1	30	15	0.15	L				
		GT30J301	600	30	60	155	TO-3P(N)	Built-in FRD	2.1	30	15	0.15	L				
		GT50J102	600	50	100	200	TO-3P(LH)	◆	2.1	50	15	0.15	L				

► 600-V Fast IGBTs (4th Generation)

(FS: Fast Switching)

Main Applications	Features	Part Number	Absolute Maximum Ratings				Package	Circuit Configuration (*1)	VCE(sat) Typ.			tr Typ.	Load (*2)	Remarks			
			V _{CES} (V)	I _c		P _c			(V)	@I _c (A)	@V _{GE} (V)						
				DC (A)	Pulsed (A)	T _c = 25°C (W)											
Inverter power supplies (UPS/PFC/motor)	Fast switching	GT30J121	600	30	60	170	TO-3P(N)	◆	2.0	30	15	0.05	L				
		GT30J126	600	30	60	90	TO-3P(N)IS	◆	1.95	30	15	0.05	L	Isolation Package			
		GT30J324	600	30	60	170	TO-3P(N)	Built-in FRD	2.0	30	15	0.05	L				
		GT50J121	600	50	100	240	TO-3P(LH)	◆	2.0	50	15	0.05	L				
		GT50J325	600	50	100	240	TO-3P(LH)	Built-in FRD	2.0	50	15	0.05	L				

► 600-V IGBTs for Low Frequency Switching

Main Applications	Features	Part Number	Absolute Maximum Ratings				Package	Circuit Configuration (*1)	VCE(sat) Typ.			tr Typ.	Load (*2)	Remarks			
			V _{CES} (V)	I _c		P _c			(V)	@I _c (A)	@V _{GE} (V)						
				DC (A)	Pulsed (A)	T _c = 25°C (W)											
Power factor correction	Low-frequency switching	GT30J122	600	30	100	75	TO-3P(N)IS	◆	2.1	50	15	0.25	R	Partial Switching Converter			
		GT30J122A	600	30	100	120	TO-3P(N)	◆	1.7	50	15	0.2	R	Partial Switching Converter			
		GT40J121	600	40	100	80	TO-3P(N)IS	◆	1.45	40	15	0.2	R	Partial Switching Converter			

*1 ◆ : Single

FRD: Fast Recovery Diode

*2 R : Resistive load

L : Inductive load

: New product

5-2 Soft-Switching Applications

Static inverters in IH cooktops, IH rice cookers and microwave ovens utilize a soft-switching technique which exhibits low switching loss. Toshiba offers IGBTs suitable for soft-switching applications.

Microwave Ovens



IH Rice Cookers



IH Cookers



MFPs



AC Input Voltage	Circuit	IGBT Rating
100 V to 120 V	<p>Voltage Resonance</p>	<p>$V_{CES} = 900 \text{ V to } 1050 \text{ V}$ $I_c = 15 \text{ A to } 60 \text{ A}$</p>
200 V to 240 V		<p>$V_{CES} = 1200 \text{ V to } 1500 \text{ V}$ $I_c = 40 \text{ A}$</p>
100 V to 240 V	<p>Current Resonance</p>	<p>$V_{CES} = 600 \text{ V}$ $I_c = 30 \text{ A to } 60 \text{ A}$</p>

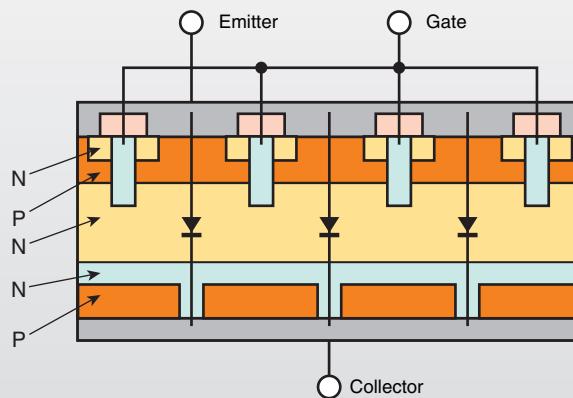
IH: Induction heating
MFP: Multifunction Printer

5-2 Soft-Switching Applications

6.5th-Generation RC-IGBT Series (New Products)

The RC-IGBT (Reverse-Conducting IGBT) Series consists of a freewheeling diode monolithically integrated in an IGBT chip. This is realized by forming an N layer through the P layer on the collector side. The RC-IGBT Series is environmentally friendly since it eliminates the need for a separate diode. Additionally, it also features a reduced thermal resistance of the freewheeling diode.

► Cross-Sectional View of the RC-IGBT



Product Lineup

► For soft switching

Main Applications	Features	Part Number	Absolute Maximum Ratings					Package	Circuit Configuration (*1)	V _{CE(sat)} Typ. @ Ta = 25°C			tr Typ. @ Ta = 25°C (μs)	Load (*2)	Remarks
			V _{CES} (V)	I _c		P _c				(V)	I _c (A)	V _{GE} (V)			
IH rice cookers and IH cooktops	AC 100 V	GT35MR21	900	35	100	82	150	TO-3P(N)IS	Built-in FWD	1.6	35	15	0.2	R	6.5th generation
		GT50MR21	900	50	100	230	175	TO-3P(N)	Built-in FWD	1.7	50	15	0.18	R	6.5th generation T _j = 175°C
		GT50NR21	1050	50	100	230	175	TO-3P(N)	Built-in FWD	1.8	50	15	0.2	R	6.5th generation T _j = 175°C
		GT40QR21	1200	40	80	230	175	TO-3P(N)	Built-in FWD	1.9	40	15	0.2	R	6.5th generation T _j = 175°C

*1 Abbreviation in the "Circuit Configuration" column

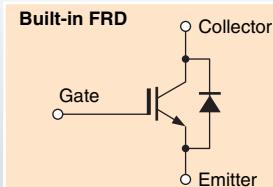
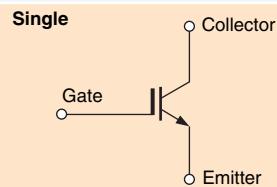
: New product

FWD: Free-Wheeling Diode

*2 Abbreviation in the "Load" column

R : Resistive load

► Circuit Configurations



IGBTs for Soft-Switching Applications

Main Applications	Features	Part Number	Absolute Maximum Ratings					Package	Circuit Configuration (*1)	V _{CE(sat)} Typ.		t _r Typ. (*2)	Load (*2)	Remarks
			V _{CES} (V)	I _c		P _c	T _j = 25°C (W)			@ I _c (A)	@ V _{GE} (V)			
IH rice cookers and IH cooktops	AC 200 V	GT30J322	600	30	100	75	150	TO-3P(N)IS	Built-in FRD	2.1	50	15	0.25	R
		GT35J321	600	37	100	75	150	TO-3P(N)IS	Built-in FRD	1.9	50	15	0.19	R
		GT40J321	600	40	100	120	150	TO-3P(N)	Built-in FRD	2.0	40	15	0.11	R
		GT40J322	600	40	100	120	150	TO-3P(N)	Built-in FRD	1.7	40	15	0.2	R
		GT40J323	600	40	100	170	150	TO-3P(N)	Built-in FRD	2.0	40	15	0.06	R
		GT40J325	600	40	100	80	150	TO-3P(N)IS	Built-in FRD	1.45	40	15	0.2	R
		GT50J322	600	50	100	130	150	TO-3P(LH)	Built-in FRD	2.1	50	15	0.25	R
		GT50J322H	600	50	100	130	150	TO-3P(LH)	Built-in FRD	2.2	50	15	0.11	R
		GT50J327	600	50	100	140	150	TO-3P(N)	Built-in FRD	1.9	50	15	0.19	R
		GT50J341	600	50	100	200	175	TO-3P(N)	Built-in FRD	1.6	50	15	0.15	R
		GT50J328	600	50	120	140	150	TO-3P(N)	Built-in FRD	2.0	50	15	0.10	R
AC 100 V	Voltage resonance	GT60J321	600	60	120	200	150	TO-3P(LH)	Built-in FRD	1.55	60	15	0.30	R
		GT60J323	600	60	120	170	150	TO-3P(LH)	Built-in FRD	1.9	60	15	0.16	R
		GT60J323H	600	60	120	170	150	TO-3P(LH)	Built-in FRD	2.1	60	15	0.12	R
		GT15M321	900	15	30	55	150	TO-3P(N)IS	Built-in FWD	1.8	15	15	0.20	R
		GT50M322	900	50	120	156	150	TO-3P(N)	Built-in FWD	2.1	60	15	0.25	R
		GT60M324	900	60	120	254	175	TO-3P(N)	Built-in FWD	1.7	60	15	0.11	R
AC 200 V	AC 100 V	GT50N322A	1000	50	120	156	150	TO-3P(N)	Built-in FWD	2.2	60	15	0.10	R
		GT50N324	1000	50	120	150	150	TO-3P(N)	Built-in FWD	1.9	60	15	0.11	R
		GT60N321	1000	60	120	170	150	TO-3P(LH)	Built-in FWD	2.3	60	15	0.25	R
		GT40T321	1500	40	80	230	175	TO-3P(N)	Built-in FWD	2.15	40	15	0.24	R

*1 Abbreviations in the "Circuit Configuration" column

: New product

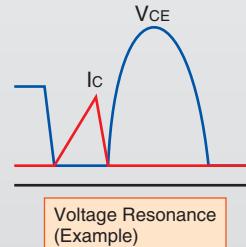
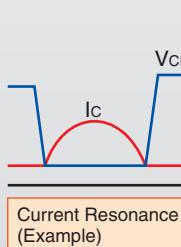
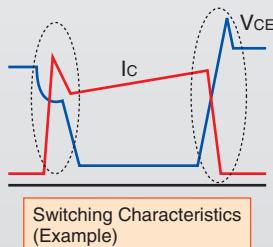
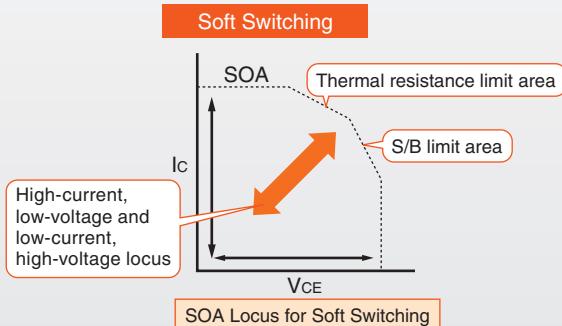
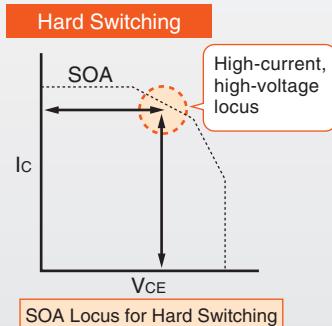
FRD: Fast Recovery Diode, FWD: Free-Wheeling Diode

*2 Abbreviation in the "Load" column

R : Resistive load

5-2 Soft-Switching Applications

► Comparisons Between Hard and Soft Switching (diagrams shown only as a guide)



5-3 Strobe Flash Applications

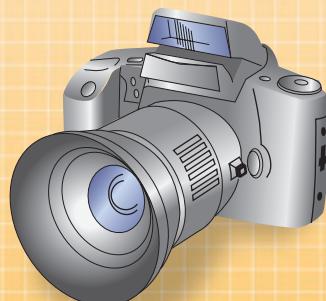
Strobe flash control is now prevalent in digital still cameras. Package sizes are getting smaller, and logic levels are increasingly used to represent the gate drive voltage. Toshiba offers compact IGBTs featuring low gate drive voltage.

- As a voltage-controlled device, the IGBT requires only a few components for drive circuit.
- IGBTs require fewer components for the strobe flash circuit (compared to SCRs).
- Strobe flash IGBTs are capable of switching large currents.

DSC, Compact Camera



Single-Lens Reflex Camera



5-3 Strobe Flash Applications

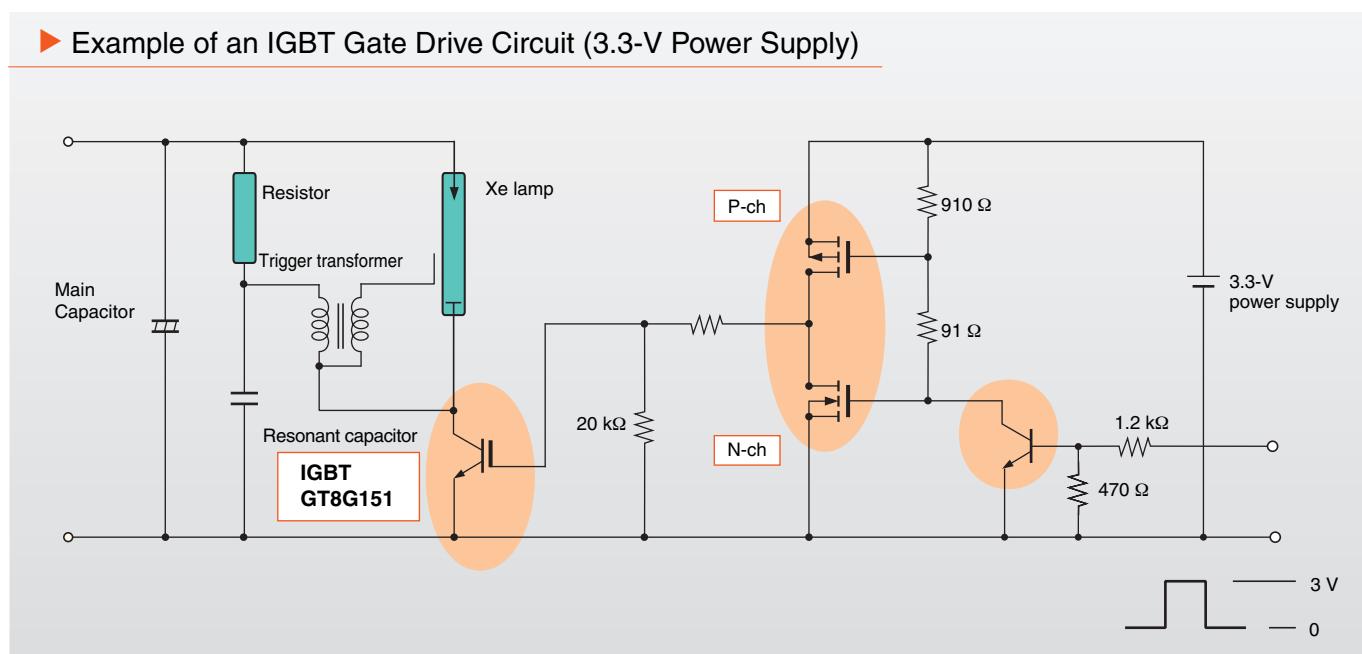
Product Lineup

► For strobe flashes

2.5-V to 4.0-V Gate Drive Series

The IGBT can operate with a gate drive voltage of 2.5 V to 4.0 V. The common 3.3-V or 5-V internal power supply in a camera can be used as a gate drive power supply to simplify the power supply circuitry. A zener diode is included between the gate and emitter to provide ESD surge protection.

► Example of an IGBT Gate Drive Circuit (3.3-V Power Supply)



3.3-V Power Supply

Part Number	V _{CES} / I _c	Gate Drive Voltage Min (V)	V _{CE(sat)} (V)		P _c (W) @Ta = 25°C	Package	Remarks
			Typ.	V _{GE} / I _c			
GT5G133	400 V / 130 A	2.5	3.0	2.5 V / 130 A	0.83	TSOn-8	7th generation
GT8G151	400 V / 150 A	2.5	2.65	2.5 V / 150 A	0.83	TSOn-8	7th generation

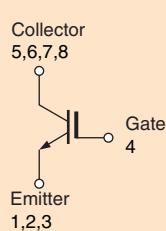
: New product

5-V Power Supply

Part Number	V _{CES} / I _c	Gate Drive Voltage Min (V)	V _{CE(sat)} (V)		P _c (W) @Ta = 25°C	Package	Remarks
			Typ.	V _{GE} / I _c			
GT8G132	400 V / 150 A	4.0	2.3	4.0 V / 150 A	1.1	SOP-8	5th generation
GT10G131	400 V / 200 A	4.0	2.3	4.0 V / 200 A	1.9	SOP-8	5th generation

<Connection Examples>

Board connection example



All the emitter terminals should be connected together.

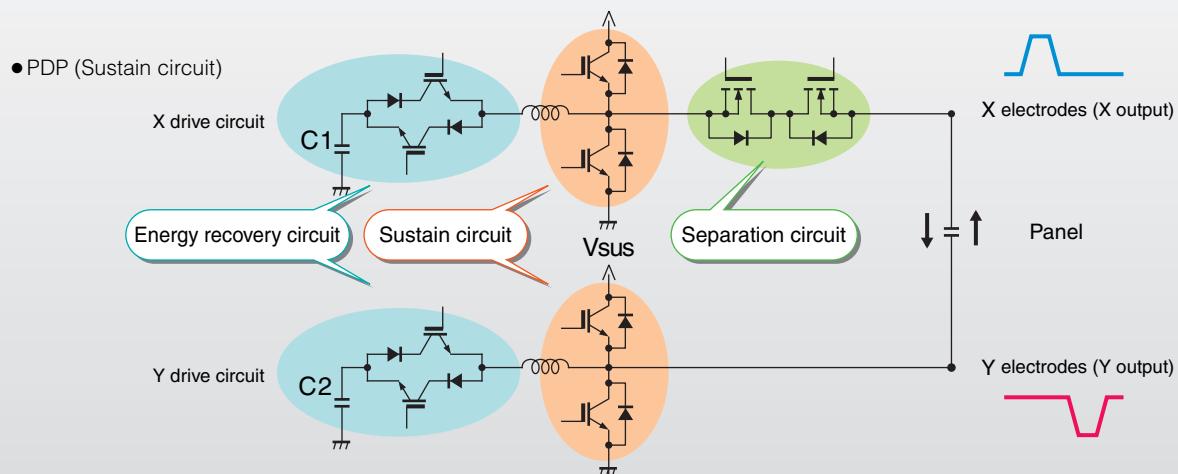
5-4 Plasma Display Panel Applications

Plasma Displays

Parallel MOSFETs have been used for the drive circuitry of plasma display panels (PDPs). Recently, however, IGBTs are commonly used in large current applications due to their superior current conduction capability.



► Example of a Plasma Display Panel Drive Circuit



Product Lineup

► For plasma display panels

300-V IGBTs

Part Number	V _{ces} / I _{cp} @ 3 μs	V _{ce(sat)} (V) Typ. @ 120 A	P _c (W) @ T _c = 25°C	Package	Remarks
GT30F124	300 V / 200 A	2.3	25	TO-220SIS	6th generation
GT30F125	330 V / 200 A	1.9	25	TO-220SIS	6th generation
GT45F127	300 V / 200 A	1.6	26	TO-220SIS	6th generation
GT45F128	330 V / 200 A	1.45	26	TO-220SIS	6th generation
GT30F131	360 V / 200 A	1.9	140	TO-220SM(MXN)	6th generation

: New product

400-V IGBTs

Part Number	V _{ces} / I _{cp} @ 3 μs	V _{ce(sat)} (V) Typ. @ 120 A	P _c (W) @ T _c = 25°C	Package	Remarks
GT30G124	430 V / 200 A	2.5	25	TO-220SIS	6th generation
GT30G125	430 V / 200 A	2.1	25	TO-220SIS	6th generation
GT45G127	430 V / 200 A	1.7	26	TO-220SIS	6th generation
GT45G128	430 V / 200 A	1.55	26	TO-220SIS	6th generation

: New product

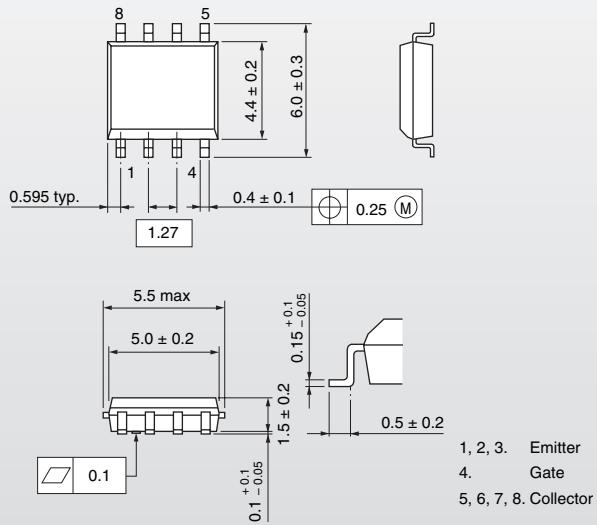
600-V IGBTs

Part Number	V _{ces} / I _{cp} @ 3 μs	V _{ce(sat)} (V) Typ. @ 120 A	P _c (W) @ T _c = 25°C	Package	Remarks
GT30J124	600 V / 200 A	2.4	26	TO-220SIS	5th generation

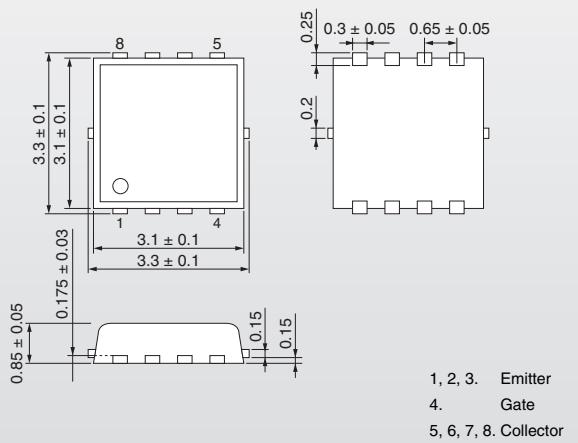
6 Package Dimensions

Unit: mm

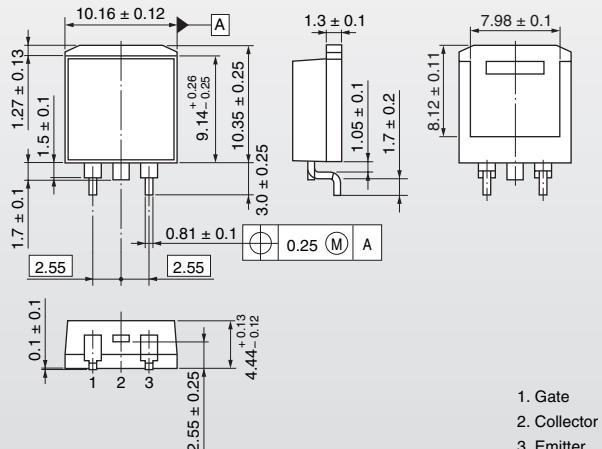
SOP-8



TSOT-8



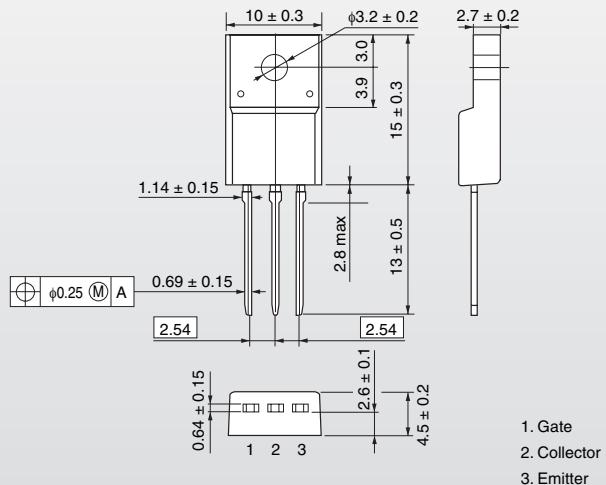
TO-220SM(MXN)



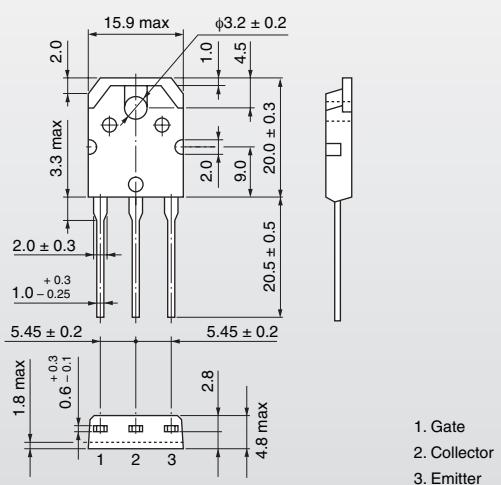
6 Package Dimensions

Unit: mm

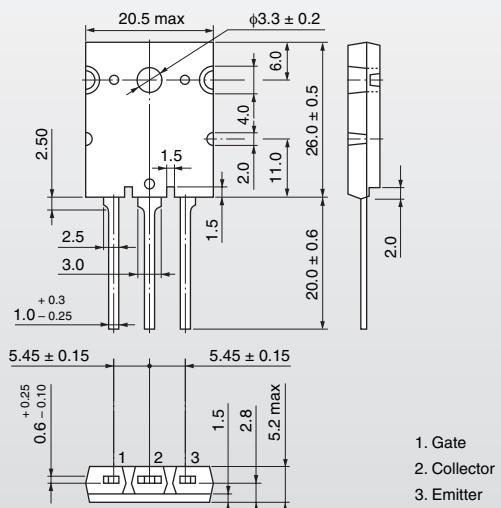
► TO-220SIS



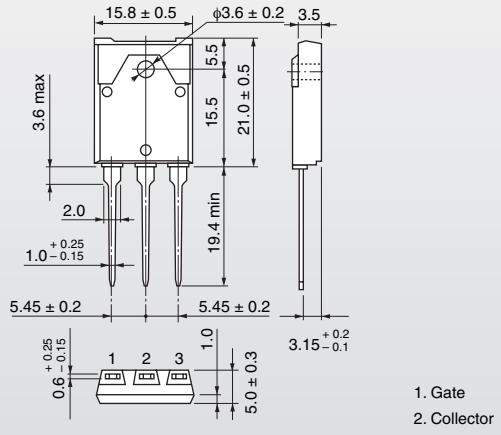
► TO-3P(N)



► TO-3P(LH)



► TO-3P(N)IS



7 Final-Phase and Obsolete Products

The following products are in stock but are being phased out of production. The recommended replacements that continue to be available are listed in the right-hand column. However, the characteristics of the recommended replacements may not be exactly the same as those of the final-phase and obsolete products. Before using a recommended replacement, be sure to check that it is suitable for use under the intended operating conditions.

Application	Final-Phase or Obsolete Product	Absolute Maximum Ratings		Package	Recommended Obsolete Replacements	Absolute Maximum Ratings		Package
		V _{ces} (V)	I _c (A) DC			V _{ces} (V)	I _c (A) DC	
Soft switching Resonant switching	MG30T1AL1	1500	30	IH	—	—	—	—
	MG60M1AL1	900	60	IH	—	—	—	—
	GT40M101	900	40	TO-3P(N)IS	—	—	—	—
	GT40M301	900	40	TO-3P(LH)	—	—	—	—
	GT40Q322	1200	39	TO-3P(N)	—	—	—	—
	GT40Q323	1200	39	TO-3P(N)	—	—	—	—
	GT40T101	1500	40	TO-3P(LH)	—	—	—	—
	GT40T301	1500	40	TO-3P(LH)	—	—	—	—
	GT50L101	800	50	TO-3P(L)	—	—	—	—
	GT50M101	900	50	TO-3P(L)	—	—	—	—
	GT50Q101	1200	50	IH	—	—	—	—
	GT50S101	1400	50	IH	—	—	—	—
	GT50T101	1500	50	IH	—	—	—	—
	GT60J101	600	60	TO-3P(L)	—	—	—	—
	GT60J322	600	60	TO-3P(LH)	—	—	—	—
	GT60M101	900	60	TO-3P(L)	—	—	—	—
	GT60M102	900	60	TO-3P(L)	—	—	—	—
	GT60M103	900	60	TO-3P(L)	—	—	—	—
	GT60M104	900	60	TO-3P(L)	—	—	—	—
	GT60M105	900	60	TO-3P(L)	—	—	—	—
	GT60M301	900	60	TO-3P(LH)	—	—	—	—
	GT60M302	900	60	TO-3P(LH)	—	—	—	—
	GT60M305	900	60	TO-3P(LH)	—	—	—	—
	GT60M322	950	60	TO-3P(LH)	GT60N321	1000	60	TO-3P(LH)
	GT60N323	1050	60	TO-3P(LH)	—	—	—	—
	GT80J101	600	80	TO-3P(L)	—	—	—	—
	GT80J101A	600	80	TO-3P(LH)	—	—	—	—
General-purpose motors General-purpose inverters	GT8J101	600	8	TO-220NIS	—	—	—	—
	GT8J102	600	8	TO-220SM	—	—	—	—
	GT8N101	1000	8	TO-3P(N)	GT10Q101	1200	10	TO-3P(N)
	GT8Q101	1200	8	TO-3P(N)	GT10Q101	1200	10	TO-3P(N)
	GT8Q102	1200	8	TO-220SM	—	—	—	—
	GT10Q311	1200	10	TO-3P(SM)	—	—	—	—
	GT15J101	600	15	TO-3P(N)	GT20J101	600	20	TO-3P(N)
	GT15J102	600	15	TO-220NIS	—	—	—	—
	GT15J103	600	15	TO-220SM	—	—	—	—
	GT15N101	1000	15	TO-3P(N)	GT15Q102	1200	15	TO-3P(N)
	GT15Q101	1200	15	TO-3P(N)	GT15Q102	1200	15	TO-3P(N)
	GT15Q311	1200	15	TO-3P(SM)	—	—	—	—
	GT20J311	600	20	TO-3P(SM)	—	—	—	—
	GT25H101	500	25	TO-3P(N)	GT30J121	600	30	TO-3P(N)
	GT25J101	600	25	TO-3P(N)	GT30J121	600	30	TO-3P(N)
	GT25J102	600	25	TO-3P(N)IS	GT30J126	600	30	TO-3P(N)IS
	GT25Q101	1200	25	TO-3P(LH)	GT25Q102	1200	25	TO-3P(LH)
	GT30J311	600	30	TO-3P(SM)	—	—	—	—
	GT50J101	600	50	TO-3P(L)	GT50J121	600	50	TO-3P(LH)
Strobe flashes	GT5G101	400	130 (pulsed)	NPM	—	—	—	—
	GT5G102	400	130 (pulsed)	DP	—	—	—	—
	GT5G103	400	130 (pulsed)	DP	—	—	—	—
	GT8G101	400	130 (pulsed)	NPM	—	—	—	—
	GT8G102	400	150 (pulsed)	NPM	—	—	—	—
	GT8G103	400	150 (pulsed)	DP	—	—	—	—
	GT8G121	400	150 (pulsed)	DP	—	—	—	—
	GT10G101	400	130 (pulsed)	TO-220NIS	—	—	—	—
	GT10G102	400	130 (pulsed)	TO-220NIS	—	—	—	—
	GT15G101	400	170 (pulsed)	TO-220NIS	—	—	—	—
	GT20G101	400	130 (pulsed)	TO-220FL	—	—	—	—
	GT20G102	400	130 (pulsed)	TO-220FL	—	—	—	—
	GT25G101	400	170 (pulsed)	TO-220FL	—	—	—	—
	GT25G102	400	150 (pulsed)	TO-220FL	—	—	—	—
Audio amps	GT50G101	400	100 (pulsed)	TO-3P(N)	—	—	—	—
	GT50G102	400	100 (pulsed)	TO-3P(N)	—	—	—	—
	GT75G101	400	150 (pulsed)	TO-3P(N)	—	—	—	—
GT20D101	250	20	TO-3P(L)	—	—	—	—	
	GT20D201	-250	-20	TO-3P(L)	—	—	—	—